

	Type	L #	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r s
1	IS&R	L1	4	(("5808360") or ("6051887")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/09 09:32		0
2	BRS	L2	4	(stack\$4 with implantable) and (wafer or semiconductor) and ("contact pad" or bump) and etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/09 11:51		0
3	BRS	L3	14	LARSON-LARY-R.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/09 10:11		0
4	BRS	L4	21	(stack\$4 and implantable) and (wafer or semiconductor) and ("contact pad" or bump) and etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/09 12:25		0
5	BRS	L6	35	5,545,581	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/09 13:55		0